FORM PTO~1595		COVER SHEET	U.S. DEPT. OF COMMERCE Patent and Trademark
Office	09-16-2	2002	Patent and Trademark
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APS02-014			
To the Honorable Commissioner of Pate	102223	5/1/ riginal doc	uments or copy thereof.
1. Name of conveying party(ies):	. 02220.	2. Name and address of rec	
TAN KIM HWEE, ROMAN PEREZ, KEE	KWANG	Name: Advanpack Solu	itions Pte. Ltd.
LAU, ALEX CHEW, ANTONIO DIMAANO			_
MED -9-6-02			Mar
mice of occ		Internal Address:	E Marie
Additional name(s) or conveying party(ies) attached?	Yes/X No		2 M 2
_		Street Address:	
3. Nature of conveyance		33 Marsiling Industria	Festato SCOTT
X Assignment Merger		Road 3, #01/03	Estate 5
A Assignment Merger		Singapore 739256	
Security Agreement Change of N	ame	Singapore	
Security Agreement Change of A	anic		
other			
Journal			
Execution Date: <u>8/6/02</u>		Additional name(s) & addres	(x) ss(es) attached? Yes
4. Application number(s) or patent number(s):	10/0	36337	
	10/2	3677 (	
If this document is being filed together with	n a new application		· · · · · · · · · · · · · · · · · · ·
A. Patent Application No(s)		B. Patent No.(s)	)
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Additiona	l numbers attache	d? Yes X No	
5. Name and address of party to whom corre	spondence	6. Total no. of applications	and patents involved:: 1
concerning document should be mailed:	·		
Name: <b>GEORGE O. SAILE</b>			
Internal Address:		7. Total fee (37 CFR 3.41):	\$ <u>40.00</u>
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City: POUGHKEEPSIE State: NY ZIP: 12603		8 .Deposit account number	
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STEPHEN B. ACKERMAN			9/6/02
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PATENT REEL: 013275 FRAME: 0312

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	For X Application or U.S. Patent			
	record **			
	By x Inventor(s) or Present Owner			
ASSEGNMENT OF INVENTION				
In consideration of the payment by ASSIGNE	E to ASSIGNOR of the sum of One Dollar (\$1.00), the			
receipt of which is hereby acknowledged, and				
ASSIGNOR:	-			
TAN KIM HWEE	ROMAN PEREZ			
Type or print name of ASSIGNOR	Type or print name of ASSIGNOR			
Address Signa Dorg	Address Signacia			
#106-69 S560104 Singapore	# 09-53 ST 30541 Simppore			
SIMBAPOZEAM	PILI7/10			
Nationality	Nationality			
KEE KWANG LAU	ALEX CHEW			
Type or print name of ASSIGNOR	Type or print name of ASSIGNOR SUK 205 YI SHUH 81 21			
Address SDAC-DOCE				
#12-829 S670337. Singapore	#04-223 \$760 20\$ Singapore			
SINGAPOREAL	SWEATOREAN			
Nationality	Nationality			
ASSIGNEE:				
Advanpack Solutions Pte. Ltd.				
33 Marsiling Industrial Estate				
Road 3, #01/03				
Singapore 739256				
Singapore				
and the currencence assigns and langitions	centatives of the ASSIGNEE			
and the successors, assigns and legal representatives of the ASSIGNEE  (complete one of the following)				
x the entire right, title and interest				
an undivided percent (%	) interest for the United States and its territorial possessions			
	ign rights are also to be assigned)			
x and in all foreign countries				
in and to any and all improvements which are disclosed in the invention entitled:				
Package Design And Method (If Manufacture For Chip Array				

PATENT REEL: 013275 FRAME: 0313

	For x U.S. and/or x Foreign Rights		
APS02-014	For x Application or U.S. Patent		
	By X Inventor(s) or Present Owner		
ASSEGNMENT OF INVENTION			
In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,			
ASSIGNOR:			
ANTONIO DIMAANO Type or print name of ASSIGNOR  ELC 541 WOODLANDS DR 16  Address STEPAPORE  \$109-53 STEPAPORE  FILL PILLO.  Nationality			
ASSIGNEE: Advanpack Solutions Pte. Ltd. 33 Marsiling Industrial Estate Road 3, #03-01/03 Singapore 739256 Singapore Nationality			
and the successors, assigns and legal repres	entatives of the ASSIGNEE one of the following)		
x the entire right, title and interest			
	interest for the United States and its territorial possessions		
(check the following Joxof foreign x and in all foreign countries	n rights are also to be assigned)		
in and to any and all improvements which are	disclosed in the invention entitled:		
Package Design and Method of Manufactor	ure For Chip Array		

PATENT REEL: 013275 FRAME: 0314

and which is found in	
a) X U.S. patent application execute	ed on even date herewith
b) U.S. patent application execute	ed on
(c) U.S. application serial no.	filed on
d) U.S. patent no.	issued
	theck (e) if foreign application(s) is also being assigned) of in a foreign country, including the right to clam priority
	e obtained for said invention by the above application or any e, thereof, and as to letters patent any re-issue or re-examination
ASSIGNOR hereby covenants that no be made or entered into which would com	o assignment, sale, agreement or encumbrance has been or will flict with this assignment.
application, said invention and said Letter or desirable to carry out the purposes the N WITNESS WHEREOF, I We have sig	
	SIGNATURE OF ASSIGNATION DIMARNO DIMAR
	Mex Chew
If ASSIGNOR is a legal entity complete the fo	ellowing information
	Type or print the name of the above person authorized to sign on behalf of ASSIGNOR
	TVAL

Note: No witnessing, notarization or legalization is necessary, if the assignment is noturized or legalized then it will only be prime facile evidence (35 USC

\_\_Notarization of Legalization Page Added.

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and which is found in	
(a) X U.S. patent application executed on ex	ren date herewith
(b) U.S. patent application executed on _	
(c) U.S. application serial nc.	filed on
(d) U.S. patent no.	issued
(also check (e)	if foreign application(s) is also being assigned)
(e) x and any legal equivalent thereof in a fo	preign country, including the right to clam priority
	ed for said invention by the above application or any of, and as to letters patent any re-issue or re-examination
ASSIGNOR hereby covenants that no assign be made or entered into which would conflict with	nment, sale, agreement or encumbrance has been or will a this assignment.
pertinent facts and documents relating to said inviting the said inviting to said inviting the said inviting the said said said said said said said said	MEE will, upon its request, be provided promptly with all rention and said Letters Patent and legal equivalents as will testify as to the same in any interference, litigation or ute and deliver to ASSIGNEE or its legal representatives red to apply for, obtain, maintain, issue and enforce said int and said equivalents thereof which may be necessary
IN WITNESS WHEREOF, I / We have signed this	
WARNING Date of signing must be the same as the date of	
	ROMAN PEREZ
If ASSIGNOR is a legal entity complete the following i	information
	Type or print the name of the above person authorized to sign on behalf of ASSIGNOR
	Title

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